

Spread Spectrum 3 DIMM Desktop Clock

Features

- Outputs
 - 4 CPU Clock (2.5V or 3.3V, 50 to 83.3MHz)
 - 7 PCI (3.3V)
 - 1 48MHz for USB (3.3V)
 - 1 24MHz for Super I/O (3.3V)
 - 2 REF (3.3V)
 - 1 IOAPIC (2.5V or 3.3V)
 - 12 SDRAM
- Serial data interface provides additional frequency selection, individual clock output disable, and other functions
- Smooth transition supports dynamic frequency assignment

- Frequency selection not affected during power down/up cycle
- Supports a variety of power saving options
- 3.3V operation
- Available in 48-pin SSOP (300 mils)

Key Specifications

| | |
|-----------------------------------|-------------------------------|
| ±0.5% Spread Spectrum Modulation: | ±0.5% |
| Jitter (cycle-to-cycle): | 250ps |
| Duty Cycle: | 45-55% |
| | 1-4ns CPU-PCI skew |
| | 250ps PCI-PCI or CPU-CPU skew |

Figure 1 Block Diagram

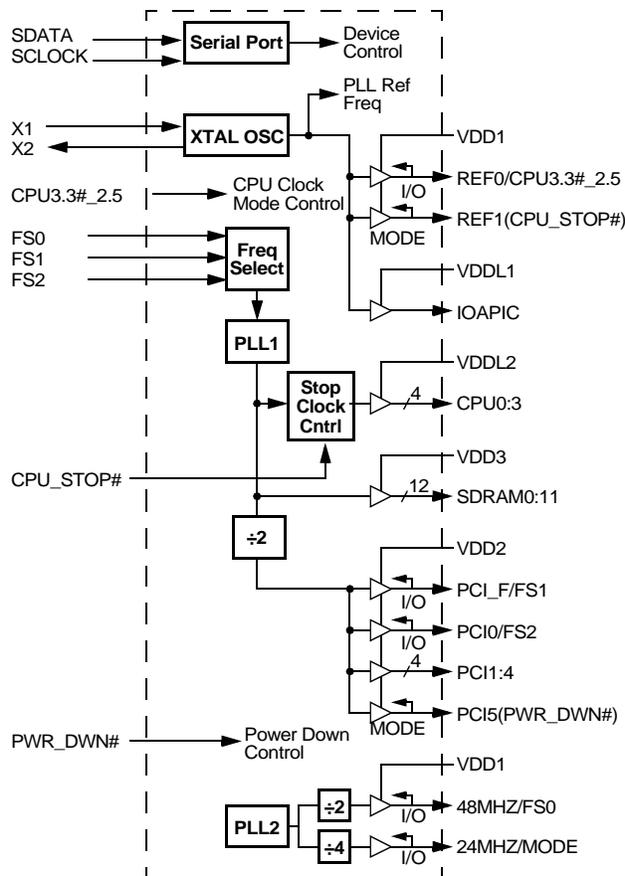


Table 1 Order Information

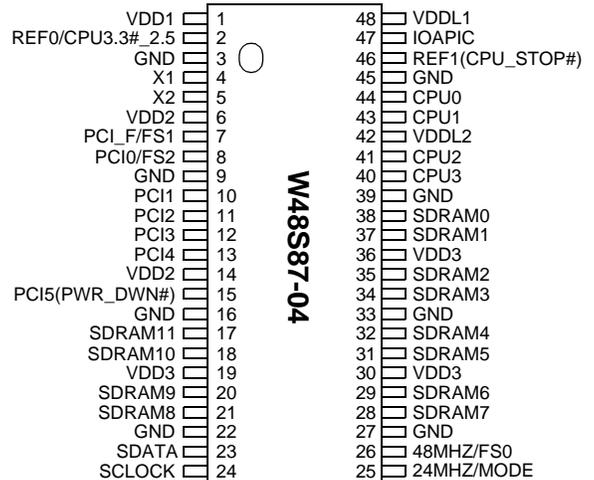
| Part Number | Freq. Mask Code | Package |
|-------------|-----------------|---------------------|
| W48S87 | 04 | H = SSOP (300 mils) |

Table 2 Pin Selectable Frequency (Note)

| Input Address | | | CPU, SDRAM Clocks (MHz) | PCI Clocks (MHz) |
|---------------|-----|-----|-------------------------|------------------|
| FS2 | FS1 | FS0 | | |
| 0 | 0 | 0 | 50.0 | 25.0 |
| 0 | 0 | 1 | 75.0 | 32.0 |
| 0 | 1 | 0 | 83.3 | 41.65 |
| 0 | 1 | 1 | 68.5 | 34.25 |
| 1 | 0 | 0 | 55.0 | 27.5 |
| 1 | 0 | 1 | 75.0 | 37.5 |
| 1 | 1 | 0 | 60.0 | 30.0 |
| 1 | 1 | 1 | 66.8 | 33.4 |

Note: Additional frequency selections provided by serial data interface; refer to Table 6 on page 8.

Figure 2 Pin Diagram



Note: Signal names in parenthesis denotes function is selectable through mode pin register strapping.

Overview

The W48S87-04, a motherboard clock synthesizer, can provide either a 2.5V or 3.3V CPU clock swing making it suitable for a variety of CPU options. Twelve SDRAM clocks are provided in phase with the CPU clock outputs. This provides clock support for up to three SDRAM DIMMs. Fixed output frequency clocks are provided for other system functions.

Functional Description

I/O Pin Operation

Pins 2, 7, 8, 25 and 26 are dual purpose I/O pins. Upon power up these pins act as logic inputs, allowing the determination of assigned device functions. A short time after power up, the logic state of these pins is latched and the pins then become clock outputs. This feature reduces device pin count by combining clock outputs with input select pins.

An external 10 kohm "strapping" resistor is connected between each I/O pin and ground or VDD3. Connection to ground sets a latch to "0", connection to VDD3 sets a latch to "1". Figure 3 and Figure 4 show two suggested methods for strapping resistor connection.

Upon W48S87-04 power up, the first 2ms of operation is used for input logic selection. During this period, these dual

purpose I/O pins are tristated, allowing the output strapping resistor on each I/O pin to pull the pin and its associated capacitive clock load to either a logic high or low state. At the end of the 2ms period, the established logic 0 or 1 condition of each I/O pin is then latched. Next the output buffers are enabled which converts the I/O pins into operating clock outputs. The 2ms timer is started when VDD reaches 2.0V. The input bits can only be re-set by turning VDD off and then back on again.

It should be noted that the strapping resistors have no significant effect on clock output signal integrity. The drive impedance of both clock outputs is <40 ohms (nominal) which is minimally affected by the 10 kohm strap to ground or VDD. As with the series termination resistor, the output strapping resistor should be placed as close to the I/O pin as possible in order to keep the interconnecting trace short. The trace from the resistor to ground or VDD should be kept less than two inches in length to prevent system noise coupling during input logic sampling.

When the clock outputs are enabled following the 2ms input period, target (normal) output frequency is delivered assuming that VDD has stabilized. If VDD has not yet reached full value, output frequency initially may be below target but will increase to target once VDD voltage has stabilized. In either case, a short output clock cycle may be produced from the CPU clock outputs when the outputs are enabled.

Figure 3 Input Logic Selection Through Resistor Load Option

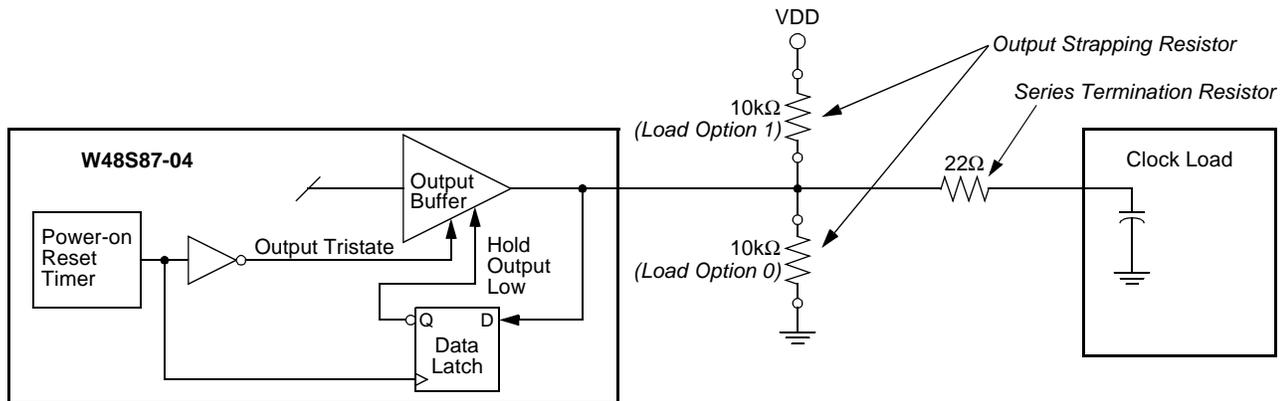
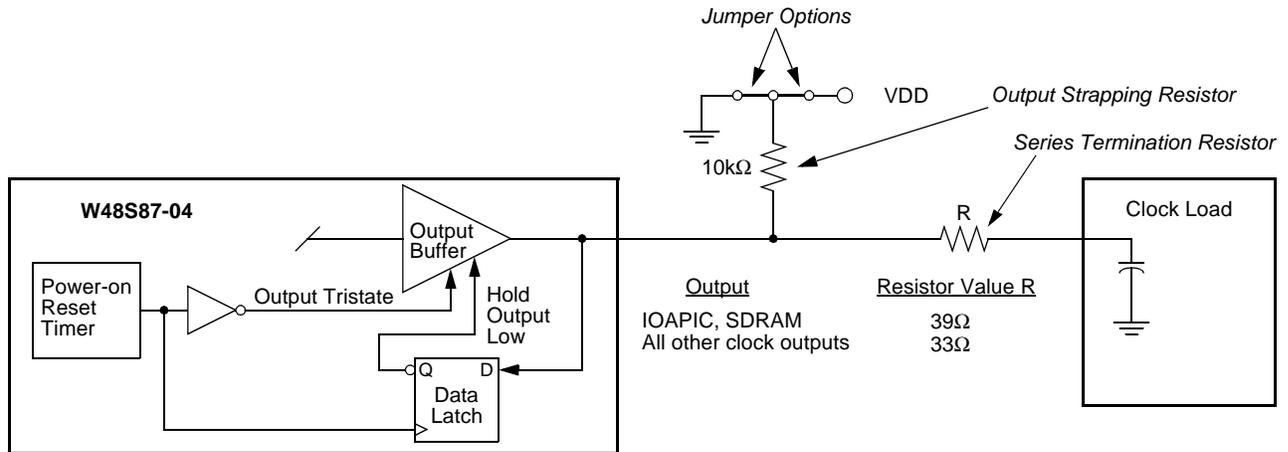


Figure 4 Input Logic Selection Through Jumper Option


CPU/PCI Frequency Selection

CPU frequency is selected with I/O pins 26, 7, and 8 (48MHz/FS0, PCI_F/FS1, and PCI0/FS2, respectively). Refer to Table 2 for CPU/PCI frequency programming information. Additional frequency selections are available through the serial data interface. Refer to Table 6, "Additional Frequency Selections through Serial Data Interface Data Bytes," on page 8.

Output Buffer Configuration

Clock Outputs

All clock outputs are designed to drive serial terminated clock lines. The W48S87-04 outputs are CMOS-type which provide rail-to-rail output swing. To accommodate the limited voltage swing required by some processors, the output buffers of CPU0:3 use a special VDDL2 power supply pin that can be tied to 2.5V nominal.

Crystal Oscillator

The W48S87-04 requires one input reference clock to synthesize all output frequencies. The reference clock can be either an externally generated clock signal or the clock gener-

ated by the internal crystal oscillator. When using an external clock signal, pin X1 is used as the clock input and pin X2 is left open. The input threshold voltage of pin X1 is VDD/2.

The internal crystal oscillator is used in conjunction with a quartz crystal connected to device pins X1 and X2. This forms a parallel resonant crystal oscillator circuit. The W48S87-04 incorporates the necessary feedback resistor and crystal load capacitors. Including typical stray circuit capacitance, the total load presented to the crystal is approximately 20pF. For optimum frequency accuracy without the addition of external capacitors, a parallel-resonant mode crystal specifying a load of 20pF should be used. This will typically yield reference frequency accuracies within ± 100 ppm.

Dual Supply Voltage Operation

The W48S87-04 is designed for dual power supply operation. Supply pins VDD1, VDD2, and VDD3 are connected to a 3.3V supply and supply power to the internal core circuit and to the clock output buffers, except for outputs CPU0:3 and IOAPIC. Supply pins VDDL1 and VDDL2 may be connected to either a 2.5V or 3.3V supply.

Spread Spectrum Clocking

The device generates a clock that is frequency modulated in order to increase the bandwidth that it occupies. By increasing the bandwidth of the fundamental and its harmonics, the amplitudes of the radiated electromagnetic emissions are reduced. This effect is depicted in Figure 5.

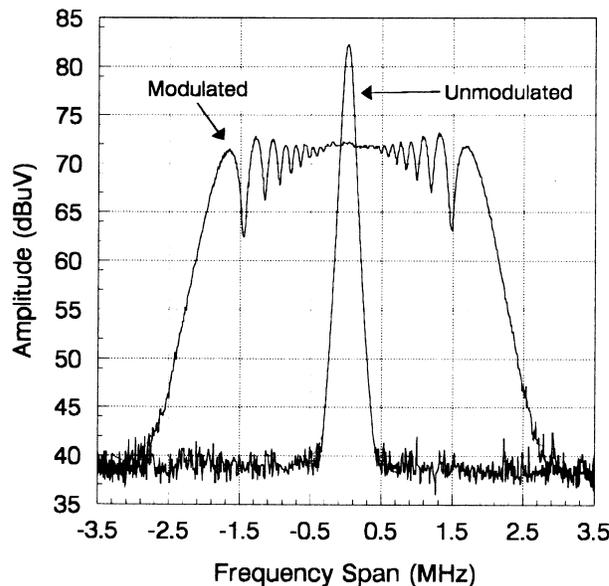
As depicted in Figure 5, a harmonic of a modulated clock has a much lower amplitude than that of an unmodulated signal. The reduction in amplitude is dependent on the harmonic number and the frequency deviation or spread. The equation for the reduction is

$$dB = 6.5 + 9 \cdot \log_{10}(P) + 9 \cdot \log_{10}(F)$$

Where P is the percentage of deviation and F is the frequency in MHz where the reduction is measured.

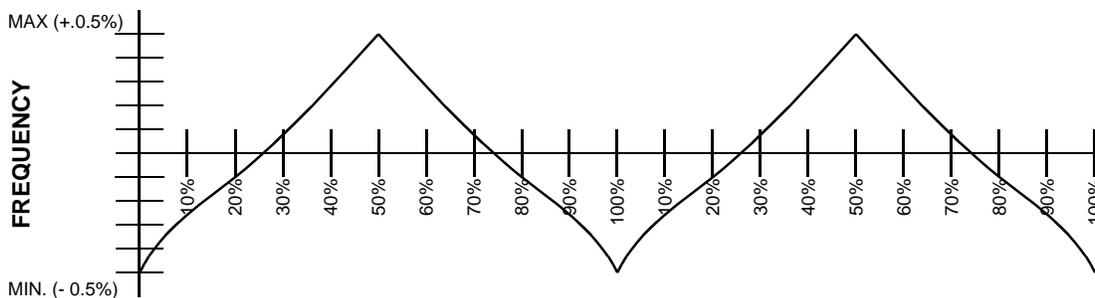
The output clock is modulated with a waveform depicted in Figure 6. This waveform, as discussed in "Spread Spectrum Clock Generation for the Reduction of Radiated Emissions" by Bush, Fessler, and Hardin produces the maximum reduction in the amplitude of radiated electromagnetic emissions. The deviation selected for this chip is $\pm 0.5\%$ of the center frequency. Figure 6 details the IC WORKS spreading pattern. IC WORKS does offer options with more spread and greater EMI reduction. Contact your local Sales representative for details on these devices.

Figure 5 Clock Harmonic with and without SSCG Modulation Frequency Domain Representation



Spread Spectrum clocking is activated or deactivated by selecting the appropriate values for bits 1-0 in data byte 0 of the I²C data stream. Refer to Table 5 for more details.

Figure 6 Typical Modulation Profile



Serial Data Interface

The W48S87-04 features a two-pin, serial data interface that can be used to configure internal register settings that control particular device functions. Upon power-up, the W48S87-04 initializes with default register settings, therefore the use of this serial data interface is optional. The serial interface is write-only (to the clock chip) and is the dedicated function of

device pins SDATA and SCLOCK. In motherboard applications, SDATA and SCLOCK are typically driven by two logic outputs of the chipset. Clock device register changes are normally made upon system initialization, if any are required. The interface can also be used during system operation for power management functions. Table 3 summarizes the control functions of the serial data interface.

Table 3 Serial Data Interface Control Functions Summary

| Control Function | Description | Common Application |
|-------------------------------|--|---|
| Clock Output Disable | Any individual clock output(s) can be disabled. Disabled outputs are actively held low. | Unused outputs are disabled to reduce EMI and system power. Examples are clock outputs to unused SDRAM DIMM socket or PCI slot. |
| CPU Clock Frequency Selection | Provides CPU/PCI frequency selections beyond the 50 and 66.8MHz selections that are provided by the FS0:2 power-on default selection. Frequency is changed in a smooth and controlled fashion. | For alternate CPU devices, and power management options. Smooth frequency transition allows CPU frequency change under normal system operation. |
| Output Tristate | Puts all clock outputs into a high impedance state. | Production PCB testing. |
| Test Mode | All clock outputs toggle in relation with X1 input, internal PLL is bypassed. Refer to Table 5. | Production PCB testing. |
| (Reserved) | Reserved function for future device revision or production device testing. | No user application. Register bit must be written as 0. |

Operation

Data is written to the W48S87-04 in ten bytes of eight bits each. Bytes are written in the order shown in Table 4.

Table 4 Byte Writing Sequence

| Byte Sequence | Byte Name | Bit Sequence | Byte Description |
|---------------|---------------|--------------|---|
| 1 | Slave Address | 11010010 | Commands the W48S87-04 to accept the bits in Data Bytes 0-6 for internal register configuration. Since other devices may exist on the same common serial data bus, it is necessary to have a specific slave address for each potential receiver. The slave receiver address for the W48S87-04 is 11010010. Register setting will not be made if the Slave Address is not correct (or is for an alternate slave receiver). |
| 2 | Command Code | Don't Care | Unused by the W48S87-04, therefore bit values are ignored (don't care). This byte must be included in the data write sequence to maintain proper byte allocation. The Command Code Byte is part of the standard serial communication protocol and may be used when writing to another addressed slave receiver on the serial data bus. |
| 3 | Byte Count | Don't Care | Unused by the W48S87-04, therefore bit values are ignored (don't care). This byte must be included in the data write sequence to maintain proper byte allocation. The Byte Count Byte is part of the standard serial communication protocol and may be used when writing to another addressed slave receiver on the serial data bus. |

Table 4 Byte Writing Sequence (cont.)

| Byte Sequence | Byte Name | Bit Sequence | Byte Description |
|---------------|-------------|------------------|--|
| 4 | Data Byte 0 | Refer to Table 5 | The data bits in these bytes set internal W48S87-04 registers that control device operation. The data bits are only accepted when the Address Byte bit sequence is 11010010, as noted above. For description of bit control functions, refer to Table 5, Data Byte Serial Configuration Map. |
| 5 | Data Byte 1 | | |
| 6 | Data Byte 2 | | |
| 7 | Data Byte 3 | | |
| 8 | Data Byte 4 | | |
| 9 | Data Byte 5 | | |
| 10 | Data Byte 6 | | |

Writing Data Bytes

Each bit in the data bytes control a particular device function except for the "reserved" bits which must be written as a logic 0. Bits are written MSB (most significant bit) first, which is bit

7. Table 5 gives the bit formats for registers located in Data Bytes 0-6. Table 6 details additional frequency selections that are available through the serial data interface. Table 7 details the select functions for Byte 0, bits 1 and 0.

Table 5 Data Bytes 0-6 Serial Configuration Map

| Bit(s) | Affected Pin | | Control Function | Bit Control | | Default |
|--------------------|--------------|----------|--|---|--|---------|
| | Pin No. | Pin Name | | 0 | 1 | |
| Data Byte 0 | | | | | | |
| 7 | -- | -- | (Reserved) | -- | -- | 0 |
| 6 | -- | -- | BYT0_SEL2 | Refer to Table 6 | | 0 |
| 5 | -- | -- | BYT0_SEL1 | Refer to Table 6 | | 0 |
| 4 | -- | -- | BYT0_SEL0 | Refer to Table 6 | | 0 |
| 3 | | | BYT0_FS# | Frequency Controlled by FS (2:0) | Frequency Controlled by BYT0_SEL (2:0) | 0 |
| 2 | 22 | | (Reserved) | | | 0 |
| 1-0 | -- | -- | Bit 1 Bit 0 0 0 Normal Operation 0 1 Test Mode 1 0 Spread Spectrum On 1 1 All Outputs Tristated | Function (See Table 7 for function details) | | 00 |
| Data Byte 1 | | | | | | |
| 7 | 26 | 48MHZ | Clock Output Disable | Low | Active | 1 |
| 6 | 25 | 24MHZ | Clock Output Disable | Low | Active | 1 |
| 5 | -- | -- | (Reserved) | -- | -- | 0 |
| 4 | -- | -- | (Reserved) | -- | -- | 0 |
| 3 | 40 | CPU3 | Clock Output Disable | Low | Active | 1 |
| 2 | 41 | CPU2 | Clock Output Disable | Low | Active | 1 |
| 1 | 43 | CPU1 | Clock Output Disable | Low | Active | 1 |
| 0 | 44 | CPU0 | Clock Output Disable | Low | Active | 1 |
| Data Byte 2 | | | | | | |
| 7 | -- | -- | (Reserved) | -- | -- | 0 |
| 6 | 7 | PCI_F | Clock Output Disable | Low | Active | 1 |
| 5 | 15 | PCI5 | Clock Output Disable | Low | Active | 1 |

Table 5 Data Bytes 0-6 Serial Configuration Map (cont.)

| Bit(s) | Affected Pin | | Control Function | Bit Control | | Default |
|--------------------|--------------|----------|----------------------|-------------|--------|---------|
| | Pin No. | Pin Name | | 0 | 1 | |
| 4 | 13 | PCI4 | Clock Output Disable | Low | Active | 1 |
| 3 | 12 | PCI3 | Clock Output Disable | Low | Active | 1 |
| 2 | 11 | PCI2 | Clock Output Disable | Low | Active | 1 |
| 1 | 10 | PCI1 | Clock Output Disable | Low | Active | 1 |
| 0 | 8 | PCI0 | Clock Output Disable | Low | Active | 1 |
| Data Byte 3 | | | | | | |
| 7 | 28 | SDRAM7 | Clock Output Disable | Low | Active | 1 |
| 6 | 29 | SDRAM6 | Clock Output Disable | Low | Active | 1 |
| 5 | 31 | SDRAM5 | Clock Output Disable | Low | Active | 1 |
| 4 | 32 | SDRAM4 | Clock Output Disable | Low | Active | 1 |
| 3 | 34 | SDRAM3 | Clock Output Disable | Low | Active | 1 |
| 2 | 35 | SDRAM2 | Clock Output Disable | Low | Active | 1 |
| 1 | 37 | SDRAM1 | Clock Output Disable | Low | Active | 1 |
| 0 | 38 | SDRAM0 | Clock Output Disable | Low | Active | 1 |
| Data Byte 4 | | | | | | |
| 7 | -- | -- | (Reserved) | -- | -- | 0 |
| 6 | -- | -- | (Reserved) | -- | -- | 0 |
| 5 | -- | -- | (Reserved) | -- | -- | 0 |
| 4 | -- | -- | (Reserved) | -- | -- | 0 |
| 3 | 17 | SDRAM11 | Clock Output Disable | Low | Active | 1 |
| 2 | 18 | SDRAM10 | Clock Output Disable | Low | Active | 1 |
| 1 | 20 | SDRAM9 | Clock Output Disable | Low | Active | 1 |
| 0 | 21 | SDRAM8 | Clock Output Disable | Low | Active | 1 |
| Data Byte 5 | | | | | | |
| 7 | -- | -- | (Reserved) | -- | -- | 0 |
| 5 | -- | -- | (Reserved) | -- | -- | 0 |
| 5 | -- | -- | (Reserved) | -- | -- | 0 |
| 4 | 47 | IOAPIC | Clock Output Disable | Low | Active | 1 |
| 3 | -- | -- | (Reserved) | -- | -- | 0 |
| 2 | -- | -- | (Reserved) | -- | -- | 0 |
| 1 | 46 | REF1 | Clock Output Disable | Low | Active | 1 |
| 0 | 2 | REF0 | Clock Output Disable | Low | Active | 1 |
| Data Byte 6 | | | | | | |
| 7 | -- | -- | (Reserved) | -- | -- | 0 |
| 6 | -- | -- | (Reserved) | -- | -- | 0 |
| 5 | -- | -- | (Reserved) | -- | -- | 0 |
| 4 | -- | -- | (Reserved) | -- | -- | 0 |
| 3 | -- | -- | (Reserved) | -- | -- | 0 |
| 2 | -- | -- | (Reserved) | -- | -- | 0 |
| 1 | -- | -- | (Reserved) | -- | -- | 0 |
| 0 | -- | -- | (Reserved) | -- | -- | 0 |

Table 6 Additional Frequency Selections through Serial Data Interface Data Bytes

| Input Conditions | | | Output Frequency | |
|------------------------|--------------------|--------------------|-------------------------|------------------|
| Data Byte 0, Bit 3 = 1 | | | CPU, SDRAM Clocks (MHz) | PCI Clocks (MHz) |
| Bit 6 BYT0_SEL2 | Bit 5 BYT0_SEL1 | Bit 4 BYT0_SEL0 | | |
| 0 | 0 | 0 | 50 | 25 |
| 0 | 0 | 1 | 75.0 | 32 |
| 0 | 1 | 0 | 83.3 | 41.65 |
| 0 | 1 | 1 | 68.5 | 34.25 |
| 1 | 0 | 0 | 55.0 | 27.5 |
| 1 | 0 | 1 | 75.0 | 37.5 |
| 1 | 1 | 0 | 60.0 | 30.0 |
| 1 | 1 | 1 | 66.8 | 33.4 |

Table 7 Select Function for Data Byte 0, Bits 0:1

| Function | Input Conditions | | Output Conditions | | | |
|--------------------|------------------|-------|----------------------|-------------------|-------------------|----------|
| | Data Byte 0 | | CPU0:3, SDRAM0:11 | PCI_F, PCI0:5 | REF0:1, IOAPIC | 48/24MHZ |
| | Bit 1 | Bit 0 | | | | |
| Normal Operation | 0 | 0 | Note 1 | Note 1 | 14.318MHz | 48/24MHz |
| Test Mode | 0 | 1 | X1/2 | X1/4 | X1 | Note 2 |
| Spread Spectrum On | 1 | 0 | Note 1 SS±0.5% | Note 1 SS±0.5% | 14.318MHz | 48/24MHz |
| Tristate | 1 | 1 | Hi-Z | Hi-Z | Hi-Z | Hi-Z |

Notes: 1. CPU, SDRAM and PCI frequency selections are listed in Table 2 and Table 6.

2. In Test Mode, the 48/24MHz clock outputs are:
- X1/2 for 48MHz output
 - X1/4 for 24MHz output

How To Use the Serial Data Interface

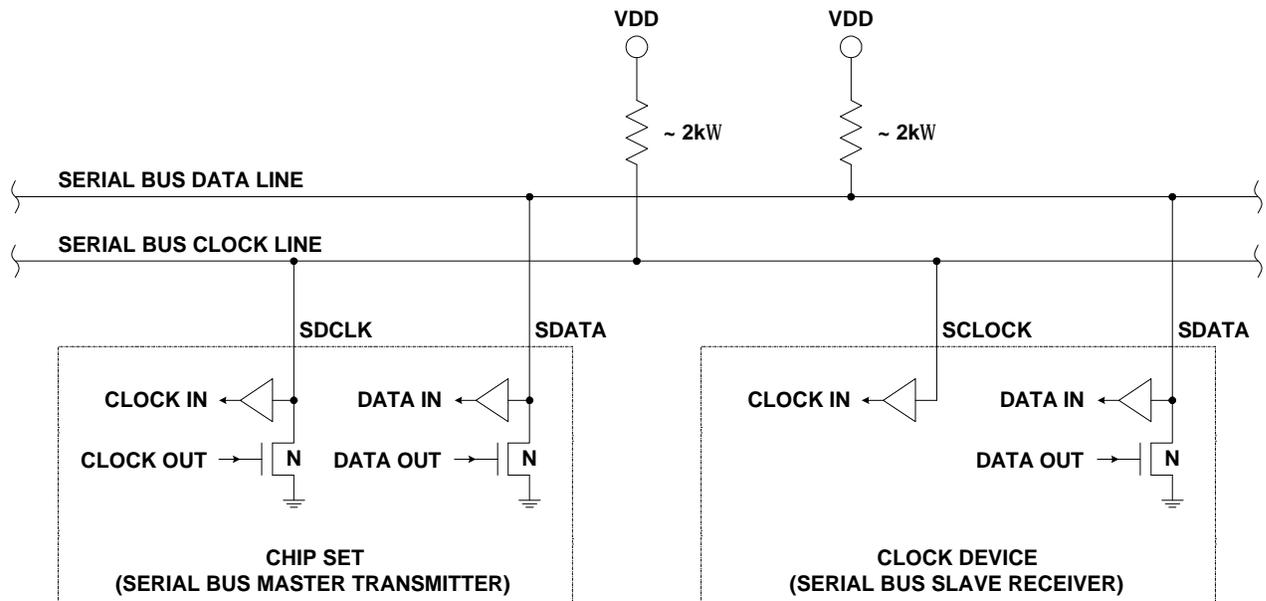
Electrical Requirements

Figure 7 illustrates electrical characteristics for the serial interface bus used with the W48S87-04. Devices send data over the bus with an open drain logic output that can (a) pull the bus line low, or (b) let the bus default to logic 1. The pull-up resistors on the bus (both clock and data lines) establish a default logic 1. All bus devices generally have logic inputs to receive data.

Although the W48S87-04 is a receive-only device (no data write-back capability), it does transmit an "acknowledge" data pulse after each byte is received. Thus, the SDATA line can both transmit and receive data.

The pull-up resistor should be sized to meet the rise and fall times specified in AC parameters, taking into consideration total bus line capacitance.

Figure 7 Serial Interface Bus Electrical Characteristics



Signaling Requirements

As shown in Figure 8, valid data bits are defined as stable logic 0 or 1 condition on the data line during a clock high (logic 1) pulse. A transitioning data line during a clock high pulse may be interpreted as a start or stop pulse (it will be interpreted as a start or stop pulse if the start/stop timing parameters are met).

A write sequence is initiated by a "start bit" as shown in Figure 9. A "stop bit" signifies that a transmission has ended.

As stated previously, the W48S87-04 sends an "acknowledge" pulse after receiving eight data bits in each byte as shown in Figure 10.

Sending Data to the W48S87-04

The device accepts data once it has detected a valid start bit and address byte sequence. Device functionality is changed upon the receipt of each data bit (registers are not double buffered). Partial transmission is allowed meaning that a transmission can be truncated as soon as the desired data bits are transmitted (remaining registers will be unmodified). Transmission is truncated with either a stop bit or new start bit (restart condition).

Figure 8 Serial Data Bus Valid Data Bit

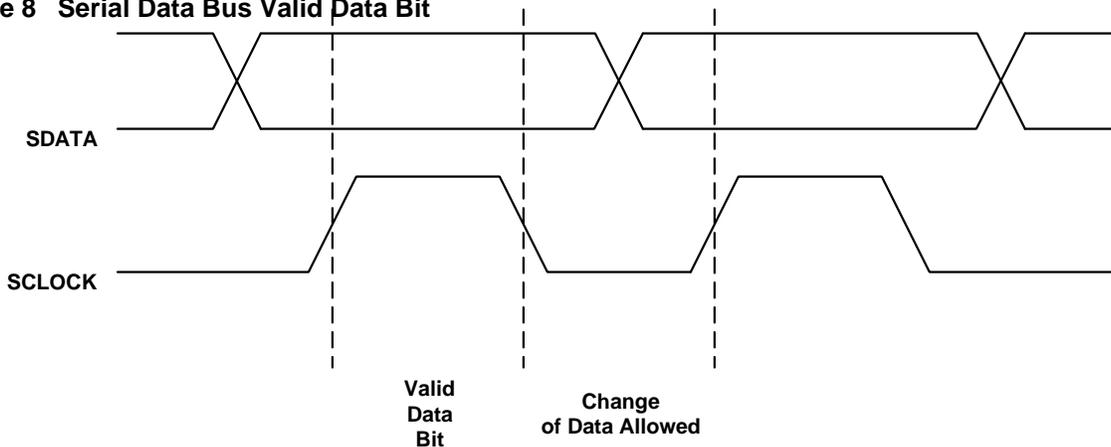


Figure 9 Serial Data Bus Start and Stop Bit

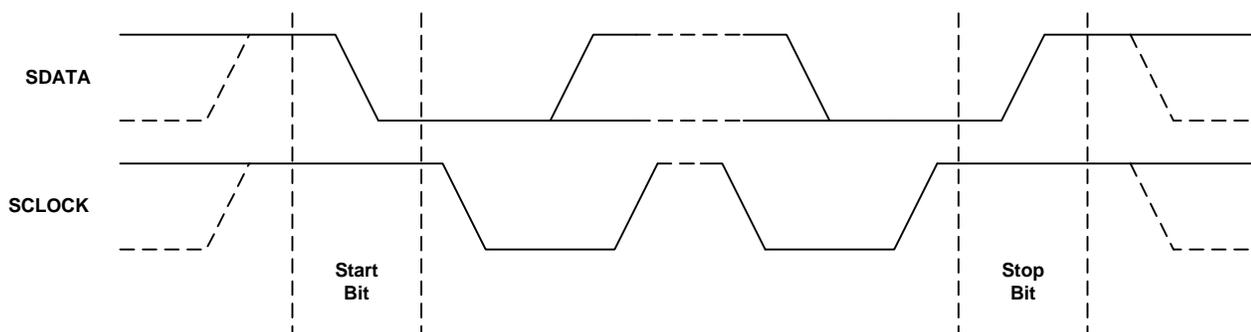


Figure 10 Serial Data Bus Write Sequence

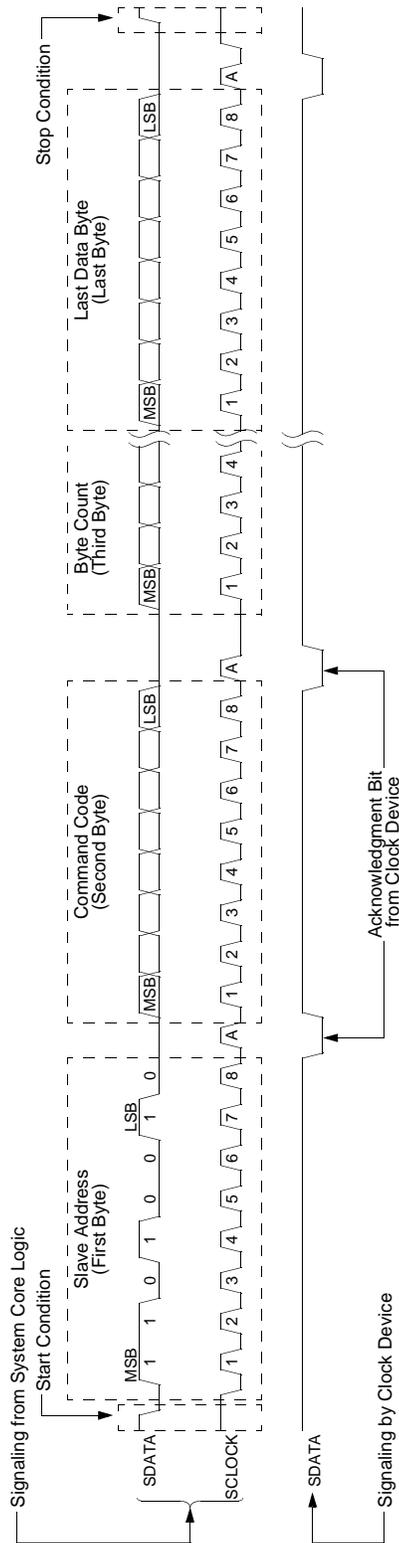
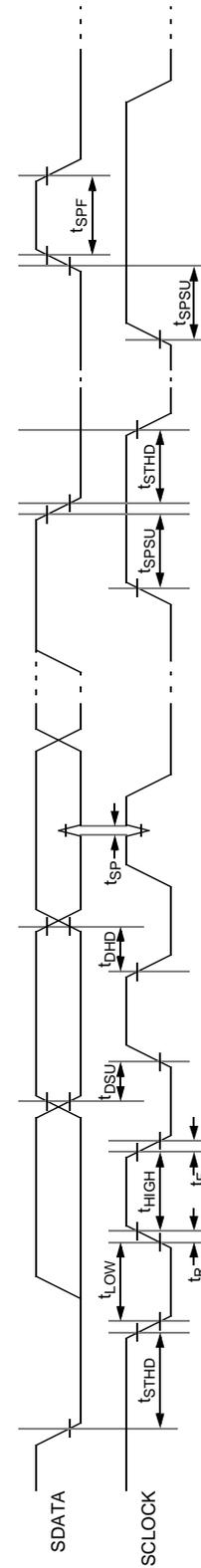


Figure 11 Serial Data Bus Timing Diagram



Pin Definitions

| Pin Name | Pin No. | Pin Type | Pin Description |
|----------------|---|----------|---|
| CPU0:3 | 44, 43, 41, 40 | O | CPU Clock Outputs 0 through 3: These four CPU clock outputs are controlled by the CPU_STOP# control pin. Output voltage swing is controlled by voltage applied to VDDL2 and output characteristics are adjusted by input CPU3.3#_2.5. |
| PCI_F/FS1 | 7 | I/O | Fixed PCI Clock Output and Frequency Selection Bit 1: As an output, this pin works in conjunction with PCI0:5. Output voltage swing is controlled by voltage applied to VDD2. When an input, this pin functions as part of the frequency selection address. The value of FS0:2 determines the power-up default frequency of device output clocks as per the Table 2, "Pin Selectable Frequency" on page 1. |
| PCI0/FS2 | 8 | I/O | PCI Bus Clock Output 0 and Frequency Selection Bit 2: As an output, this pin works in conjunction with PCI1:5 and PCI_F. Output voltage swing is controlled by voltage applied to VDD2. When an input, this pin functions as part of the frequency selection address. The value of FS0:2 determines the power-up default frequency of device output clocks as per the Table 2, "Pin Selectable Frequency" on page 1. |
| PCI1:4 | 10, 11, 12, 13 | O | PCI Bus Clock Outputs 1 through 4: Output voltage swing is controlled by voltage applied to VDD2. |
| PCI5(PWR_DWN#) | 15 | I/O | PCI Bus Clock Output 5 or Power Down Control: As an output, this pin works in conjunction with PCI0:4 and PCI_F. Output voltage swing is controlled by voltage applied to VDD2. If programmed as an input (refer to MODE pin description), this pin is used for power down control. When low, the device goes into a low power standby condition. All outputs are actively held low while in power down. CPU, SDRAM and PCI clock outputs are stopped low after completing a full clock cycle (2-4 CPU clock cycle latency). When brought high, CPU, SDRAM and PCI outputs start with a full clock cycle at full operating frequency (3ms maximum latency). |
| SDRAM0:11 | 38, 37, 35, 34, 32, 31, 29, 28, 21, 20, 18, 17 | O | SDRAM Clock Outputs 0 through 11: These twelve SDRAM clock outputs run synchronous to the CPU clock outputs. Output voltage swing is controlled by voltage applied to VDD3. |
| IOAPIC | 47 | O | I/O APIC Clock Output: Provides 14.318MHz fixed frequency. The output voltage swing is controlled by VDDL1. |
| 48MHZ/FS0 | 26 | I/O | 48MHz Output and Frequency Selection Bit 0: Fixed clock output that defaults to 48MHz following device power-up. Output voltage swing is controlled by voltage applied to VDD1. When an input, this pin functions as part of the frequency selection address. The value of FS0:2 determines the power-up default frequency of device output clocks as per the Table 2, "Pin Selectable Frequency" on page 1. |

Pin Definitions (cont.)

| Pin Name | Pin No. | Pin Type | Pin Description | | | | | | | | | |
|--------------------|-------------------------------------|-------------------|---|--------------------|-------------------------------------|---------------|------|------------------|-------------------|---|---------------|---------------|
| 24MHZ/MODE | 25 | I/O | <p>24MHz Output and Mode Control Input: Fixed clock output that defaults to 24MHz following device power-up. Output voltage swing is controlled by voltage applied to VDD1.</p> <p>When an input, this pin is used for pin programming selection. It determines the functions for pins 15 and 46:</p> <table border="0"> <tr> <td>MODE</td> <td>Pin 15</td> <td>Pin 46</td> </tr> <tr> <td>0</td> <td>PWR_DWN# (input)</td> <td>CPU_STOP# (input)</td> </tr> <tr> <td>1</td> <td>PCI5 (output)</td> <td>REF1 (output)</td> </tr> </table> | MODE | Pin 15 | Pin 46 | 0 | PWR_DWN# (input) | CPU_STOP# (input) | 1 | PCI5 (output) | REF1 (output) |
| MODE | Pin 15 | Pin 46 | | | | | | | | | | |
| 0 | PWR_DWN# (input) | CPU_STOP# (input) | | | | | | | | | | |
| 1 | PCI5 (output) | REF1 (output) | | | | | | | | | | |
| REF0/CPU3.3#_2.5 | 2 | I/O | <p>Fixed 14.318MHz Output 0 and CPU Output Voltage Swing Selection Input: As an output, this pin is used for various system applications. Output voltage swing is controlled by voltage applied to VDD1. REF0 is stronger than REF1 and should be used for driving ISA slots.</p> <p>When an input, this pin selects the CPU clock output buffer characteristics that are optimized for either 3.3V or 2.5V operation.</p> <table border="0"> <tr> <td>CPU3.3#_2.5</td> <td>VDDQ2 Voltage (CPU0:3 Swing)</td> </tr> <tr> <td>0</td> <td>3.3V</td> </tr> <tr> <td>1</td> <td>2.5V</td> </tr> </table> <p>This input adjusts CPU clock output impedance so that a nominal 20 ohm output impedance is maintained. This eliminates or reduces the need to adjust external clock tuning components when changing VDDL2 voltage. CPU clock phase is also adjusted so that both CPU and SDRAM and CPU-to-PCI clock skew is maintained over the two VDDL2 voltage options. This input does not adjust IOAPIC clock output characteristics.</p> | CPU3.3#_2.5 | VDDQ2 Voltage (CPU0:3 Swing) | 0 | 3.3V | 1 | 2.5V | | | |
| CPU3.3#_2.5 | VDDQ2 Voltage (CPU0:3 Swing) | | | | | | | | | | | |
| 0 | 3.3V | | | | | | | | | | | |
| 1 | 2.5V | | | | | | | | | | | |
| REF1(CPU_Stop#) | 46 | I/O | <p>Fixed 14.318MHz Output 0 or CPU Clock Output Stop Control: Used for various system applications. Output voltage swing is controlled by voltage applied to VDD1. REF0 is stronger than REF1 and should be used for driving ISA slots.</p> <p>If programmed as an input (refer to MODE pin description), this pin is used for stopping the CPU clock outputs. When brought low, clock outputs CPU0:3 are stopped low after completing a full clock cycle (2-3 CPU clock latency). When brought high, clock outputs CPU0:3 are starting beginning with a full clock cycle (2-3 CPU clock latency).</p> | | | | | | | | | |
| X1 | 4 | I | <p>Crystal Connection or External Reference Frequency Input: This pin has dual functions. It can be used as an external 14.318MHz crystal connection or as an external reference frequency input.</p> | | | | | | | | | |
| X2 | 5 | I | <p>Crystal Connection: An input connection for an external 14.318MHz crystal. If using an external reference, this pin must be left unconnected.</p> | | | | | | | | | |
| SDATA | 23 | I | <p>Serial Data Input: Data input for Serial Data Interface. Refer to Serial Data Interface section that follows.</p> | | | | | | | | | |
| SCLOCK | 24 | I | <p>Serial Clock Input: Clock input for Serial Data Interface. Refer to Serial Data Interface section that follows.</p> | | | | | | | | | |
| VDD1 | 1 | P | <p>Power Connection: Power supply for crystal oscillator and REF0:1 output buffers. Connected to 3.3V supply.</p> | | | | | | | | | |
| VDD2 | 6,14 | P | <p>Power Connection: Power supply for PCI clock output buffers. Connected to 3.3V supply.</p> | | | | | | | | | |
| VDDL1 | 48 | P | <p>Power Connection: Power supply for IOAPIC output buffer. Connected to 2.5V or 3.3V supply.</p> | | | | | | | | | |

Pin Definitions (cont.)

| Pin Name | Pin No. | Pin Type | Pin Description |
|----------|------------------------------------|----------|---|
| VDDL2 | 42 | P | Power Connection: Power supply for CPU clock output buffers. Connected to 2.5V or 3.3V supply. |
| VDD3 | 19, 30, 36 | P | Power Connection: Power supply for SDRAM clock output buffers. Connected to 3.3V supply. |
| GND | 3, 9, 16, 22, 27, 33, 39, 45 | G | Ground Connection: Connect all ground pins to the common system ground plane. |

Absolute Maximum Ratings

Stresses greater than those listed in this table may cause permanent damage to the device. These represent a stress rating only. Operation of the device at these or any other con-

ditions above those specified in the operating sections of this specification is not implied. Maximum conditions for extended periods may affect reliability.

| Symbol | Parameter | Rating | Unit |
|------------------|--|--------------|------|
| V_{DD}, V_{IN} | Voltage on any pin with respect to GND | -0.5 to +7.0 | V |
| T_{STG} | Storage Temperature | -65 to +150 | °C |
| T_B | Ambient Temperature under Bias | -55 to +125 | °C |
| T_A | Operating Temperature | 0 to +70 | °C |
| ESD_{PROT} | Input ESD Protection | 2 (min) | kV |

Crystal Oscillator

| Symbol | Parameter | Min | Typ | Max | Unit | Test Condition |
|-------------|---|-----|------|-----|------|--------------------|
| V_{TH} | X1 Input threshold Voltage (Note 3) | | 1.65 | | V | |
| C_{LOAD} | Load Capacitance, Seen By external crystal (Note 4) | | 20 | | pF | |
| $C_{IN,X1}$ | X1 Input Capacitance (Note 5) | | 40 | | pF | Pin X2 unconnected |

3.3V DC Electrical Characteristics (CPU3.3#_2.5 Input = 0)

$T_A = 0^\circ\text{C to } +70^\circ\text{C}$, $V_{DD1:3} = V_{DDL1:2} = 3.3V \pm 5\%$ (3.135-3.465V)

| Symbol | Parameter | Min | Typ | Max | Unit | Test Condition | |
|-----------------------|------------------------------|---------------|-----|-----|---------------|---|------------------------|
| Supply Current | | | | | | | |
| I_{DD} | Combined 3.3V Supply Current | | | 365 | mA | CPU0:3 = 66.8MHz Outputs Loaded (Note 1) | |
| Logic Inputs | | | | | | | |
| V_{IL} | Input Low Voltage | | | 0.8 | V | | |
| V_{IH} | Input High Voltage | 2.0 | | | V | | |
| I_{IL} | Input Low Current (Note 2) | | | 10 | μA | | |
| I_{IH} | Input High Current (Note 2) | | | 10 | μA | | |
| Clock Outputs | | | | | | | |
| V_{OL} | Output Low Voltage | | | 50 | mV | $I_{OL} = 1\text{mA}$ | |
| V_{OH} | Output High Voltage | 3.1 | | | V | $I_{OH} = -1\text{mA}$ | |
| I_{OL} | Output Low Current: | CPU0:3 | 55 | 75 | 105 | mA | $V_{OL} = 1.5\text{V}$ |
| | | SDRAM0:11 | 80 | 110 | 155 | | |
| | | PCI_F, PCI0:5 | 55 | 75 | 105 | | |
| | | IOAPIC | 100 | 135 | 190 | | |
| | | REF0 | 60 | 75 | 90 | | |
| | | REF1 | 45 | 60 | 75 | | |
| | | 48/24MHZ | 55 | 75 | 105 | | |

3.3V DC Electrical Characteristics (CPU3.3#_2.5 Input = 0) (cont.)

$T_A = 0^\circ\text{C to } +70^\circ\text{C}$, $V_{DD1:3} = V_{DDL1:2} = 3.3\text{V}\pm 5\%$ (3.135-3.465V)

| Symbol | Parameter | Min | Typ | Max | Unit | Test Condition | |
|-----------------------------------|--|---------------|-----|-------------|---------------|------------------------------------|------------------------|
| I_{OH} | Output High Current: | CPU0:3 | 55 | 85 | 125 | mA | $V_{OH} = 1.5\text{V}$ |
| | | SDRAM0:11 | 80 | 120 | 175 | | |
| | | PCI_F, PCI0:5 | 55 | 85 | 125 | | |
| | | IOAPIC | 100 | 150 | 220 | | |
| | | REF0 | 60 | 85 | 110 | | |
| | | REF1 | 45 | 65 | 90 | | |
| | | 48/24MHZ | 55 | 85 | 125 | | |
| Pin Capacitance/Inductance | | | | | | | |
| C_{IN} | Input Pin Capacitance | | | 5 | pF | Except X1 and X2 | |
| C_{OUT} | Output Pin Capacitance | | | 6 | pF | | |
| L_{IN} | Input Pin Inductance | | | 7 | nH | | |
| Serial Input Port | | | | | | | |
| V_{IL} | Input Low Voltage | | | $0.3V_{DD}$ | V | $V_{DD} = 3.3\text{V}$ | |
| V_{IH} | Input High Voltage | $0.7V_{DD}$ | | | V | $V_{DD} = 3.3\text{V}$ | |
| I_{IL} | Input Low Current | | | 10 | μA | No internal pull-up/down on SCLOCK | |
| I_{IH} | Input High Current | | | 10 | μA | No internal pull-up/down on SCLOCK | |
| I_{OL} | Sink Current into SDATA, Open Drain N-Channel Device On | 6 | | | mA | $I_{OL} = 0.3V_{DD}$ | |
| C_{IN} | Input Capacitance of SDATA and SCLOCK | | | 10 | pF | | |
| C_{SDATA} | Total Capacitance of SDATA Bus | | | 400 | pF | | |
| C_{SCLOCK} | Total Capacitance of SCLOCK Bus | | | 400 | pF | | |

- Notes:**
1. All clock outputs loaded with maximum lump capacitance test load specified in AC Electrical Characteristics section.
 2. W48S87-04 logic inputs have internal pull-up devices.
 3. X1 input threshold voltage (typical) is $V_{DD}/2$.
 4. The W48S87-04 contains an internal crystal load capacitor between pin X1 and ground and another between pin X2 and ground. Total load seen by crystal is 20pF; this includes typical stray capacitance of short PCB traces to crystal.
 5. X1 input capacitance is applicable when driven X1 with an external clock source (X2 is left unconnected).
 6. CPU0:3 loaded by 60 Ω , 6-inch long transmission lines ending with 20pF capacitors.

2.5V DC Electrical Characteristics (CPU3.3#_2.5 Input = 1)
 $T_A = 0^{\circ}\text{C to } +70^{\circ}\text{C}$, $V_{DD1:3} = 3.3\text{V} \pm 5\%$ (3.135-3.456V), $V_{DDL1:2} = 2.5\text{V} \pm 5\%$ (2.375-2.625V)

| Symbol | Parameter | Min | Typ | Max | Unit | Test Condition | |
|-----------------------------------|-----------------------------|-------------|-----|-------------|---------------|---|-------------------------|
| Supply Current | | | | | | | |
| $I_{DD-3.3V}$ | 3.3V Supply Current | | | 300 | mA | CPU0:3 = 66.4MHz Outputs Loaded (Note 1) | |
| $I_{DD-2.5}$ | 2.5V Supply Current | | | 50 | mA | CPU0:3= 66.4MHz Outputs Loaded (Note 1) | |
| Logic Inputs | | | | | | | |
| V_{IL} | Input Low Voltage | | | 0.8 | V | | |
| V_{IH} | Input High Voltage | 2.0 | | | V | | |
| I_{IL} | Input Low Current (Note 2) | | | 10 | μA | | |
| I_{IH} | Input High Current (Note 2) | | | 10 | μA | | |
| Clock Outputs | | | | | | | |
| V_{OL} | Output Low Voltage | | | 50 | mV | $I_{OL} = 1\text{mA}$ | |
| V_{OH} | Output High Voltage | 2.2 | | | V | $I_{OH} = -1\text{mA}$ | |
| I_{OL} | Output Low Current: | CPU0:3 | 45 | 70 | 105 | mA | $V_{OL} = 1.25\text{V}$ |
| | | IOAPIC | 55 | 85 | 130 | | $V_{OL} = 1.25\text{V}$ |
| I_{OH} | Output High Current: | CPU0:3 | 40 | 65 | 95 | mA | $V_{OH} = 1.25\text{V}$ |
| | | IOAPIC | 50 | 80 | 120 | | $V_{OH} = 1.25\text{V}$ |
| Pin Capacitance/Inductance | | | | | | | |
| C_{IN} | Input Pin Capacitance | | | 5 | pF | Except X1 and X2 | |
| C_{OUT} | Output Pin Capacitance | | | 6 | pF | | |
| L_{IN} | Input Pin Inductance | | | 7 | nH | | |
| Serial Input Port | | | | | | | |
| V_{IL} | Input Low Voltage | | | $0.3V_{DD}$ | V | $V_{DD} = 2.5\text{V}$ | |
| V_{IH} | Input High Voltage | $0.7V_{DD}$ | | | V | $V_{DD} = 2.5\text{V}$ | |

- Notes:**
1. All clock outputs loaded with maximum lump capacitance test load specified in AC Electrical Characteristics section.
 2. W48S87-04 logic inputs have internal pull-up devices.
 3. X1 input threshold voltage (typical) is $V_{DD}/2$.
 4. The W48S87-04 contains an internal crystal load capacitor between pin X1 and ground and another between pin X2 and ground. Total load as seen by crystal is 20pF; this includes typical stray capacitance of short PCB traces to crystal.
 5. X1 input capacitance is applicable when driven X1 with an external clock source (X2 is left unconnected).
 6. CPU0:3 loaded by 60 Ω , 6-inch long transmission lines ending with 20pF capacitors.

3.3V AC Electrical Characteristics (CPU3.3#_2.5 Input = 0)

T_A = 0°C to +70°C, VDD1:3 = VDD1:3 = 3.3V±5% (3.135-3.465V), f_{XTL} = 14.31818MHz

Spread Spectrum function turned off

AC clock parameters are tested and guaranteed over stated operating conditions using the stated lump capacitive load at the clock output.

CPU Clock Outputs, CPU0:3 (Lump Capacitance Test Load = 20pF)

| Symbol | Parameter | CPU = 66.8MHz | | | CPU = 60MHz | | | Unit | Test Condition/Comments |
|-----------------|--|---------------|-----|-----|-------------|-----|-----|------|--|
| | | Min | Typ | Max | Min | Typ | Max | | |
| t _P | Period | 15 | | | 16.7 | | | ns | Measured on rising edge at 1.5V. |
| f | Frequency, Actual | 66.8 | | | 59.876 | | | MHz | Determined by PLL divider ratio. |
| t _H | High Time | 5.2 | | | 6 | | | ns | Duration of clock cycle above 2.4V. |
| t _L | Low Time | 5 | | | 5.8 | | | ns | Duration of clock cycle below 0.4V. |
| t _R | Output Rise Edge Rate | 1 | | 4 | 1 | | 4 | V/ns | Measured from 0.4V to 2.4V. |
| t _F | Output Fall Edge Rate | 1 | | 4 | 1 | | 4 | V/ns | Measured from 2.4V to 0.4V. |
| t _D | Duty Cycle | 45 | | 55 | 45 | | 55 | % | Measured on rising and falling edge at 1.5V. |
| t _{JC} | Jitter, Cycle-to-Cycle | | | 250 | | | 250 | ps | Measured on rising edge at 1.5V. Maximum difference of cycle time between two adjacent cycles. |
| t _{SK} | Output Skew | | | 250 | | | 250 | ps | Measured on rising edge at 1.5V. |
| f _{ST} | Frequency Stabilization from Power-up (cold start) | | | 3 | | | 3 | ms | Assumes full supply voltage reached within 1ms from power-up. Short cycles exist prior to frequency stabilization. |
| Z _o | AC Output Impedance | 15 | 20 | 30 | 15 | 20 | 30 | ohm | Average value during switching transition. Used for determining series termination value. |

SDRAM Clock Outputs, SDRAM0:11 (Lump Capacitance Test Load = 30pF)

| Symbol | Parameter | CPU = 66.8MHz | | | CPU = 60MHz | | | Unit | Test Condition/Comments |
|-----------------|--|---------------|-----|-----|-------------|-----|-----|------|--|
| | | Min | Typ | Max | Min | Typ | Max | | |
| t _P | Period | 15 | | | 16.7 | | | ns | Measured on rising edge at 1.5V. |
| f | Frequency, Actual | 66.8 | | | 59.876 | | | MHz | Determined by PLL divider ratio. |
| t _R | Output Rise Edge Rate | 1 | | 4 | 1 | | 4 | V/ns | Measured from 0.4V to 2.4V. |
| t _F | Output Fall Edge Rate | 1 | | 4 | 1 | | 4 | V/ns | Measured from 2.4V to 0.4V. |
| t _D | Duty Cycle | 45 | | 55 | 45 | | 55 | % | Measured on rising and falling edge at 1.5V. |
| t _{JC} | Jitter, Cycle-to-Cycle | | | 250 | | | 250 | ps | Measured on rising edge at 1.5V. Maximum difference of cycle time between two adjacent cycles. |
| t _{SK} | Output Skew | | 100 | | | 100 | | ps | Measured on rising edge at 1.5V. |
| t _{SK} | CPU to SDRAM Clock Skew | | | 500 | | | 500 | ps | Covers all CPU/SDRAM outputs. Measured on rising edge at 1.5V. |
| f _{ST} | Frequency Stabilization from Power-up (cold start) | | | 3 | | | 3 | ms | Assumes full supply voltage reached within 1ms from power-up. Short cycles exist prior to frequency stabilization. |
| Z _o | AC Output Impedance | 10 | 15 | 20 | 10 | 15 | 20 | ohm | Average value during switching transition. Used for determining series termination value. |

3.3V AC Electrical Characteristics (CPU3.3#_2.5 Input = 0) (cont.)
PCI Clock Outputs, PCI_F and PCI0:5 (Lump Capacitance Test Load = 30pF)

| Symbol | Parameter | CPU = 66.8MHz | | | CPU = 60MHz | | | Unit | Test Condition/Comments |
|-----------------|--|---------------|-----|-----|-------------|-----|-----|------|--|
| | | Min | Typ | Max | Min | Typ | Max | | |
| t _P | Period | 30 | | | 33.3 | | | ns | Measured on rising edge at 1.5V. |
| f | Frequency, Actual | 33.4 | | | 29.938 | | | MHz | Determined by PLL divider ratio. |
| t _H | High Time | 12 | | | 13.3 | | | ns | Duration of clock cycle above 2.4V. |
| t _L | Low Time | 12 | | | 13.3 | | | ns | Duration of clock cycle below 0.4V. |
| t _R | Output Rise Edge Rate | 1 | | 4 | 1 | | 4 | V/ns | Measured from 0.4V to 2.4V. |
| t _F | Output Fall Edge Rate | 1 | | 4 | 1 | | 4 | V/ns | Measured from 2.4V to 0.4V. |
| t _D | Duty Cycle | 45 | | 55 | 45 | | 55 | % | Measured on rising and falling edge at 1.5V. |
| t _{JC} | Jitter, Cycle-to-Cycle | | | 250 | | | 250 | ps | Measured on rising edge at 1.5V. Maximum difference of cycle time between two adjacent cycles. |
| t _{SK} | Output Skew | | | 250 | | | 250 | ps | Measured on rising edge at 1.5V. |
| t _O | CPU to PCI Clock Skew | 1 | | 4 | 1 | | 4 | ns | Covers all CPU/PCI outputs. Measured on rising edge at 1.5V. CPU leads PCI output. |
| f _{ST} | Frequency Stabilization from Power-up (cold start) | | | 3 | | | 3 | ms | Assumes full supply voltage reached within 1ms from power-up. Short cycles exist prior to frequency stabilization. |
| Z _O | AC Output Impedance | 15 | 20 | 30 | 15 | 20 | 30 | ohm | Average value during switching transition. Used for determining series termination value. |

IOAPIC Clock Output (Lump Capacitance Test Load = 20pF)

| Symbol | Parameter | CPU = 60/66.8MHz | | | Unit | Test Condition/Comments |
|-----------------|--|------------------|-----|-----|------|--|
| | | Min | Typ | Max | | |
| f | Frequency, Actual | 14.31818 | | | MHz | Frequency generated by crystal oscillator. |
| t _R | Output Rise Edge Rate | 1 | | 4 | V/ns | Measured from 0.4V to 2.4V. |
| t _F | Output Fall Edge Rate | 1 | | 4 | V/ns | Measured from 2.4V to 0.4V. |
| t _D | Duty Cycle | 45 | | 55 | % | Measured on rising and falling edge at 1.5V. |
| f _{ST} | Frequency Stabilization from Power-up (cold start) | | | 1.5 | ms | Assumes full supply voltage reached within 1ms from power-up. Short cycles exist prior to frequency stabilization. |
| Z _O | AC Output Impedance | 8 | 12 | 15 | ohm | Average value during switching transition. Used for determining series termination value. |

3.3V AC Electrical Characteristics (CPU3.3#_2.5 Input = 0) (cont.)

REF0 Clock Output (Lump Capacitance Test Load = 45pF)

| Symbol | Parameter | CPU = 60/66.8MHz | | | Unit | Test Condition/Comments |
|-----------------|--|------------------|-----|-----|------|--|
| | | Min | Typ | Max | | |
| f | Frequency, Actual | 14.31818 | | | MHz | Frequency generated by crystal oscillator. |
| t _R | Output Rise Edge Rate | 1 | | 4 | V/ns | Measured from 0.4V to 2.4V. |
| t _F | Output Fall Edge Rate | 1 | | 4 | V/ns | Measured from 2.4V to 0.4V. |
| t _D | Duty Cycle | 40 | | 60 | % | Measured on rising and falling edge at 1.5V. |
| f _{ST} | Frequency Stabilization from Power-up (cold start) | | | 1.5 | ms | Assumes full supply voltage reached within 1ms from power-up. Short cycles exist prior to frequency stabilization. |
| Z _o | AC Output Impedance | 17 | 20 | 25 | ohm | Average value during switching transition. Used for determining series termination value. |

REF1 Clock Output (Lump Capacitance Test Load = 20pF)

| Symbol | Parameter | CPU = 60/66.8MHz | | | Unit | Test Condition/Comments |
|-----------------|--|------------------|-----|-----|------|--|
| | | Min | Typ | Max | | |
| f | Frequency, Actual | 14.31818 | | | MHz | Frequency generated by crystal oscillator. |
| t _R | Output Rise Edge Rate | 1 | | 4 | V/ns | Measured from 0.4V to 2.4V. |
| t _F | Output Fall Edge Rate | 1 | | 4 | V/ns | Measured from 2.4V to 0.4V. |
| t _D | Duty Cycle | 40 | | 55 | % | Measured on rising and falling edge at 1.5V. |
| f _{ST} | Frequency Stabilization from Power-up (cold start) | | | 1.5 | ms | Assumes full supply voltage reached within 1ms from power-up. Short cycles exist prior to frequency stabilization. |
| Z _o | AC Output Impedance | 20 | 25 | 35 | ohm | Average value during switching transition. Used for determining series termination value. |

3.3V AC Electrical Characteristics (CPU3.3#_2.5 Input = 0) (cont.)
48/24MHZ Clock Outputs (Lump Capacitance Test Load = 20pF)

| Symbol | Parameter | CPU = 60/66.8MHz | | | Unit | Test Condition/Comments |
|-----------------|--|------------------|-----|-----|------|--|
| | | Min | Typ | Max | | |
| f | Frequency, Actual | 48.008/24.004 | | | MHz | Determined by PLL divider ratio (see n/m below). |
| f _D | Deviation from 48MHz | +167 | | | ppm | (48.008 – 48)/48 |
| m/n | PLL Ratio | 57/17 | | | | (14.31818MHz x 57/17 = 48.008MHz) |
| t _R | Output Rise Edge Rate | 1 | | 4 | V/ns | Measured from 0.4V to 2.4V. |
| t _F | Output Fall Edge Rate | 1 | | 4 | V/ns | Measured from 2.4V to 0.4V. |
| t _D | Duty Cycle | 40 | | 55 | % | Measured on rising and falling edge at 1.5V. |
| t _{JC} | Jitter, Cycle-to-Cycle | | | 500 | ps | Measured on rising edge at 1.5V. Maximum difference of cycle time between two adjacent cycles. |
| f _{ST} | Frequency Stabilization from Power-up (cold start) | | | 3 | ms | Assumes full supply voltage reached within 1ms from power-up. Short cycles exist prior to frequency stabilization. |
| Z _o | AC Output Impedance | 15 | 20 | 30 | ohm | Average value during switching transition. Used for determining series termination value. |

Serial Input Port

| Symbol | Parameter | Min | Typ | Max | Unit | Test Condition |
|---------------------|--|-----|-----|------|------|---|
| f _{SCLOCK} | SCLOCK Frequency | 0 | | 100 | kHz | Normal Mode |
| t _{STHD} | Start Hold Time | 4.0 | | | μs | |
| t _{LOW} | SCLOCK Low Time | 4.7 | | | μs | |
| t _{HIGH} | SCLOCK High Time | 4.0 | | | μs | |
| t _{DSU} | Data Setup Time | 250 | | | ns | |
| t _{DHD} | Data Hold Time | 0 | | | ns | (Transmitter should provide a 300ns hold time to ensure proper timing at the receiver.) |
| t _R | Rise Time, SDATA and SCLOCK | | | 1000 | ns | From 0.3V _{DD} to 0.7V _{DD} |
| t _F | Fall Time, SDATA and SCLOCK | | | 300 | ns | From 0.7V _{DD} to 0.3V _{DD} |
| t _{STSU} | Stop Setup Time | 4.0 | | | μs | |
| t _{SPF} | Bus Free Time between Stop and Start Condition | 4.7 | | | μs | |
| t _{SP} | Allowable Noise Spike Pulse Width | | | 50 | ns | |

2.5V AC Electrical Characteristics (CPU3.3#_2.5 Input = 1)

$T_A = 0^\circ\text{C to } +70^\circ\text{C}$, $V_{DD1:3} = 3.3\text{V} \pm 5\%$ (3.135-3.465V), $V_{DDL1:2} = 2.5\text{V} \pm 5\%$ (2.375-2.625V),

$f_{XTL} = 14.31818\text{MHz}$

Spread Spectrum function turned off

AC clock parameters are tested and guaranteed over stated operating conditions using the stated lump capacitive load at the clock output.

CPU Clock Outputs, CPU0:3 (Lump Capacitance Test Load = 20pF)

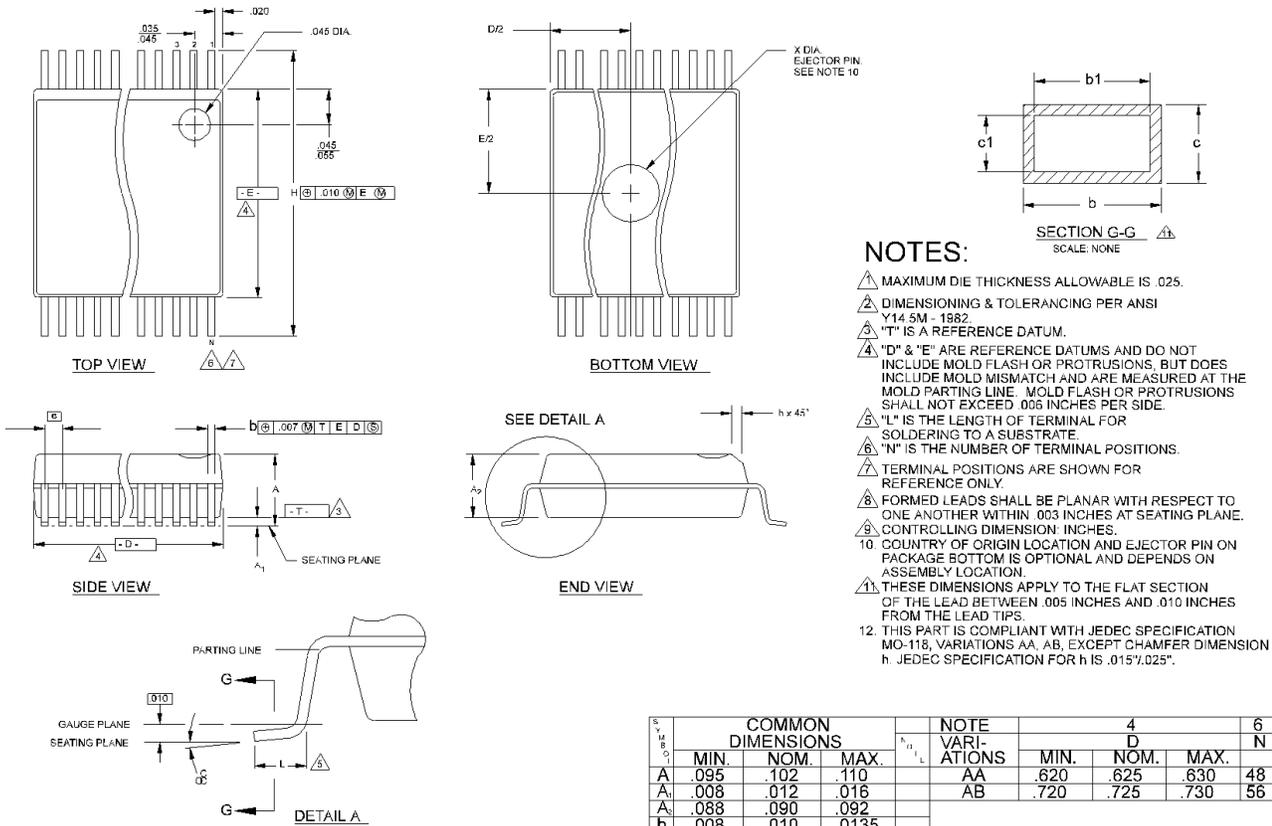
| Symbol | Parameter | CPU = 66.8MHz | | | CPU = 60MHz | | | Unit | Test Condition/Comments |
|----------|--|---------------|-----|-----|-------------|-----|-----|------|--|
| | | Min | Typ | Max | Min | Typ | Max | | |
| t_P | Period | 15 | | | 16.7 | | | ns | Measured on rising edge at 1.25V. |
| f | Frequency, Actual | 66.8 | | | 59.876 | | | MHz | Determined by PLL divider ratio. |
| t_H | High Time | 5.2 | | | 6 | | | ns | Duration of clock cycle above 2.0V. |
| t_L | Low Time | 5 | | | 5.8 | | | ns | Duration of clock cycle below 0.4V. |
| t_R | Output Rise Edge Rate | 0.8 | | 3 | 0.8 | | 3 | V/ns | Measured from 0.4V to 2.0V. |
| t_F | Output Fall Edge Rate | 0.8 | | 3 | 0.8 | | 3 | V/ns | Measured from 2.0V to 0.4V. |
| t_D | Duty Cycle | 45 | | 55 | 45 | | 55 | % | Measured on rising and falling edge at 1.25V. |
| t_{JC} | Jitter, Cycle-to-Cycle | | | 250 | | | 250 | ps | Measured on rising edge at 1.25V. Maximum difference of cycle time between two adjacent cycles. |
| t_{SK} | Output Skew | | | 250 | | | 250 | ps | Measured on rising edge at 1.25V. |
| f_{ST} | Frequency Stabilization from Power-up (cold start) | | | 3 | | | 3 | ms | Assumes full supply voltage reached within 1ms from power-up. Short cycles exist prior to frequency stabilization. |
| Z_o | AC Output Impedance | 12 | 20 | 30 | 12 | 20 | 30 | ohm | Average value during switching transition. Used for determining series termination value. |

IOAPIC Clock Output (Lump Capacitance Test Load = 20pF)

| Symbol | Parameter | CPU = 60/66.8MHz | | | Unit | Test Condition/Comments |
|----------|--|------------------|-----|-----|------|--|
| | | Min | Typ | Max | | |
| f | Frequency, Actual | 14.31818 | | | MHz | Frequency generated by crystal oscillator. |
| t_R | Output Rise Edge Rate | 1 | | 4 | V/ns | Measured from 0.4V to 2.0V. |
| t_F | Output Fall Edge Rate | 1 | | 4 | V/ns | Measured from 2.0V to 0.4V. |
| t_D | Duty Cycle | 45 | | 55 | % | Measured on rising and falling edge at 1.25V. |
| f_{ST} | Frequency Stabilization from Power-up (cold start) | | | 1.5 | ms | Assumes full supply voltage reached within 1ms from power-up. Short cycles exist prior to frequency stabilization. |
| Z_o | AC Output Impedance | 10 | 15 | 25 | ohm | Average value during switching transition. Used for determining series termination value. |

Mechanical Package Outline

Figure 12 48-Pin Small Shrink Outline Package (SSOP, 300 mils)



- NOTES:**
1. MAXIMUM DIE THICKNESS ALLOWABLE IS .025.
 2. DIMENSIONING & TOLERANCING PER ANSI Y14.5M - 1982.
 3. 'T' IS A REFERENCE DATUM.
 4. 'D' & 'E' ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, BUT DOES INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE MOLD PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006 INCHES PER SIDE.
 5. 'L' IS THE LENGTH OF TERMINAL FOR SOLDERING TO A SUBSTRATE.
 6. 'N' IS THE NUMBER OF TERMINAL POSITIONS.
 7. TERMINAL POSITIONS ARE SHOWN FOR REFERENCE ONLY.
 8. FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITHIN .003 INCHES AT SEATING PLANE.
 9. CONTROLLING DIMENSION: INCHES.
 10. COUNTRY OF ORIGIN LOCATION AND EJECTOR PIN ON PACKAGE BOTTOM IS OPTIONAL AND DEPENDS ON ASSEMBLY LOCATION.
 11. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 INCHES AND .010 INCHES FROM THE LEAD TIPS.
 12. THIS PART IS COMPLIANT WITH JEDEC SPECIFICATION MO-118, VARIATIONS AA, AB, EXCEPT CHAMFER DIMENSION h. JEDEC SPECIFICATION FOR h IS .015°/.025°.

Summary of nominal dimensions in inches:

Body Width: .296
Lead Pitch: .025
Body Length: .625
Body Height: .102

| SYMBOL | COMMON DIMENSIONS | | | NOTE VARIATIONS | 4 D | | | 6 N |
|----------------|-------------------|------|-------|-----------------|------|------|------|-----|
| | MIN. | NOM. | MAX. | | MIN. | NOM. | MAX. | |
| A | .095 | .102 | .110 | AA | .620 | .625 | .630 | 48 |
| A ₁ | .008 | .012 | .016 | AB | .720 | .725 | .730 | 56 |
| A ₂ | .088 | .090 | .092 | | | | | |
| b | .008 | .010 | .0135 | | | | | |
| b ₁ | .008 | .010 | .012 | | | | | |
| c | .005 | | .010 | | | | | |
| c ₁ | .005 | .006 | .0085 | | | | | |
| D | SEE VARIATIONS | | | 4 | | | | |
| E | .292 | .296 | .299 | | | | | |
| e | .025 BSC | | | | | | | |
| H | .400 | .406 | .410 | | | | | |
| h | .010 | .013 | .016 | | | | | |
| L | .024 | .032 | .040 | | | | | |
| N | SEE VARIATIONS | | | 6 | | | | |
| X | .085 | .093 | .100 | 10 | | | | |
| alpha | 0° | 5° | 8° | | | | | |

THIS TABLE IN INCHES

| SYMBOL | COMMON DIMENSIONS | | | NOTE VARIATIONS | 4 D | | | 6 N |
|----------------|-------------------|-------|-------|-----------------|-------|-------|-------|-----|
| | MIN. | NOM. | MAX. | | MIN. | NOM. | MAX. | |
| A | 2.41 | 2.59 | 2.79 | AA | 15.75 | 15.88 | 16.00 | 48 |
| A ₁ | 0.20 | 0.31 | 0.41 | AB | 18.29 | 18.42 | 18.54 | 56 |
| A ₂ | 2.24 | 2.29 | 2.34 | | | | | |
| b | 0.203 | 0.254 | 0.343 | | | | | |
| b ₁ | 0.203 | 0.254 | 0.305 | | | | | |
| c | 0.127 | - | 0.254 | | | | | |
| c ₁ | 0.127 | 0.152 | 0.216 | | | | | |
| D | SEE VARIATIONS | | | 4 | | | | |
| E | 7.42 | 7.52 | 7.59 | | | | | |
| e | 0.635 BSC | | | | | | | |
| H | 10.16 | 10.31 | 10.41 | | | | | |
| h | 0.25 | 0.33 | 0.41 | | | | | |
| L | 0.61 | 0.81 | 1.02 | | | | | |
| N | SEE VARIATIONS | | | 6 | | | | |
| X | 2.16 | 2.36 | 2.54 | 10 | | | | |
| alpha | 0° | 5° | 8° | | | | | |

THIS TABLE IN MILLIMETERS

IC WORKS, Inc. reserves the right to amend or discontinue this product without notice. Circuit and timing diagrams used to describe IC WORKS product operations and applications are included as a means of illustrating a typical product application. Complete information for design purposes is not necessarily given. This information has been carefully checked and is believed to be entirely reliable. IC WORKS, however, will not assume any responsibility for inaccuracies.

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